

Datasheet: MakroPorP4.2S2.5-170

Macropores silicon dead end pores on bulk substrate (430927-W08)

Etching

Size:	6 inch
Pitch:	4.2 μm trigonal
Pore length:	168 μm pore length (525 μm wafer thickness)
Pore diameter:	2.4- 2.8 μm

Postprocessing

Laserdicing 10.0 mm x 10.0 mm

Measurements

Side view

